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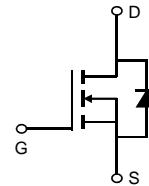
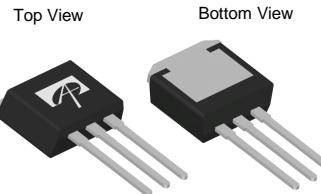
For any questions, you can email us directly:

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 ALPHA & OMEGA SEMICONDUCTOR	AOW2500 <i>150V N-Channel MOSFET</i>								
General Description <p>The AOW2500 uses Trench MOSFET technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$, Ciss and Coss. This device is ideal for boost converters and synchronous rectifiers for consumer, telecom, industrial power supplies and LED backlighting.</p>	Product Summary <table style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 50%;">V_{DS}</td><td style="width: 50%;">150V</td></tr> <tr> <td>I_D (at V_{GS}=10V)</td><td>152A</td></tr> <tr> <td>R_{DS(ON)} (at V_{GS}=10V)</td><td>< 6.2mΩ</td></tr> <tr> <td>R_{DS(ON)} (at V_{GS}=6V)</td><td>< 7.3mΩ</td></tr> </table> <p>100% UIS Tested 100% R_g Tested</p>	V _{DS}	150V	I _D (at V _{GS} =10V)	152A	R _{DS(ON)} (at V _{GS} =10V)	< 6.2mΩ	R _{DS(ON)} (at V _{GS} =6V)	< 7.3mΩ
V _{DS}	150V								
I _D (at V _{GS} =10V)	152A								
R _{DS(ON)} (at V _{GS} =10V)	< 6.2mΩ								
R _{DS(ON)} (at V _{GS} =6V)	< 7.3mΩ								



TO-262


Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V _{DS}	150	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D	152	A
T _C =100°C	I _D	107	
Pulsed Drain Current ^C	I _{DM}	440	
Continuous Drain Current	I _{DSM}	11.5	A
T _A =70°C	I _{DSM}	9.0	
Avalanche Current ^C	I _{AS}	65	A
Avalanche energy L=0.3mH ^C	E _{AS}	634	mJ
Power Dissipation ^B	P _D	375	W
T _C =100°C	P _D	187.5	
Power Dissipation ^A	P _{DSM}	2.1	W
T _A =70°C	P _{DSM}	1.3	
Junction and Storage Temperature Range	T _J , T _{STG}	-55 to 175	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A t ≤ 10s	R _{θJA}	12	15	°C/W
Maximum Junction-to-Ambient ^{A,D} Steady-State		48	60	°C/W
Maximum Junction-to-Case Steady-State	R _{θJC}	0.26	0.4	°C/W



AOW2500

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	150			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=150\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			1 5	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			± 100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2.3	2.8	3.5	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=20\text{A}$ TO262		5.1	6.2	$\text{m}\Omega$
		$T_J=125^\circ\text{C}$		9.9	12	
		$V_{GS}=6\text{V}, I_D=20\text{A}$ TO262		5.6	7.3	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS}=5\text{V}, I_D=20\text{A}$		70		S
V_{SD}	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.66	1	V
I_S	Maximum Body-Diode Continuous Current				152	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=75\text{V}, f=1\text{MHz}$		6460		pF
C_{oss}	Output Capacitance			586		pF
C_{rss}	Reverse Transfer Capacitance			22		pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	1	2.1	3.2	Ω
SWITCHING PARAMETERS						
$Q_{(10V)}$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=75\text{V}, I_D=20\text{A}$		97	136	nC
Q_{gs}	Gate Source Charge			22.5		nC
Q_{gd}	Gate Drain Charge			17		nC
$t_{\text{D(on)}}$	Turn-On DelayTime	$V_{GS}=10\text{V}, V_{DS}=75\text{V}, R_L=3.75\Omega, R_{\text{GEN}}=3\Omega$		18.5		ns
t_r	Turn-On Rise Time			20		ns
$t_{\text{D(off)}}$	Turn-Off DelayTime			67.5		ns
t_f	Turn-Off Fall Time			14		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=20\text{A}, dI/dt=500\text{A}/\mu\text{s}$		90		ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=20\text{A}, dI/dt=500\text{A}/\mu\text{s}$		1090		nC

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The Power dissipation P_{DSM} is based on $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design, and the maximum temperature of 175°C may be used if the PCB allows it.

B. The power dissipation P_D is based on $T_{J(\text{MAX})}=175^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})}=175^\circ\text{C}$. Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ\text{C}$.

D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to case $R_{\theta JC}$ and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(\text{MAX})}=175^\circ\text{C}$. The SOA curve provides a single pulse rating.

G. The maximum current limited by package.

H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$.

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AOW2500

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

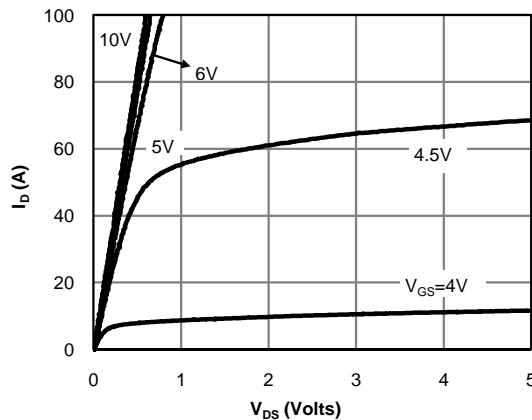


Fig 1: On-Region Characteristics (Note E)

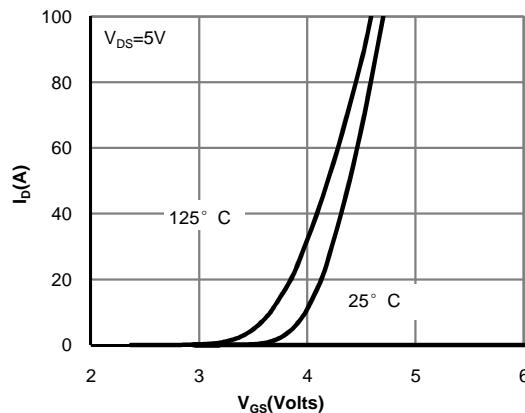


Figure 2: Transfer Characteristics (Note E)

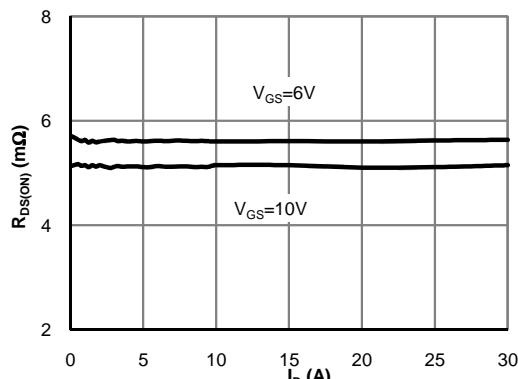


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

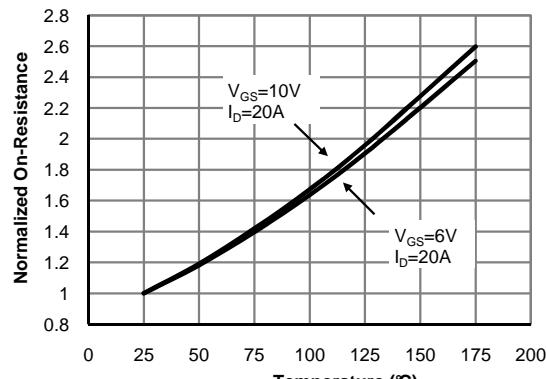


Figure 4: On-Resistance vs. Junction Temperature (Note E)

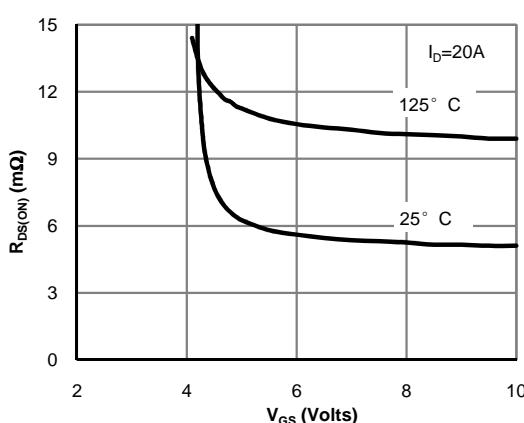


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

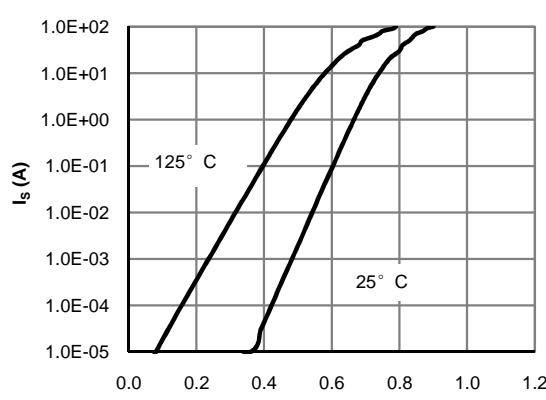
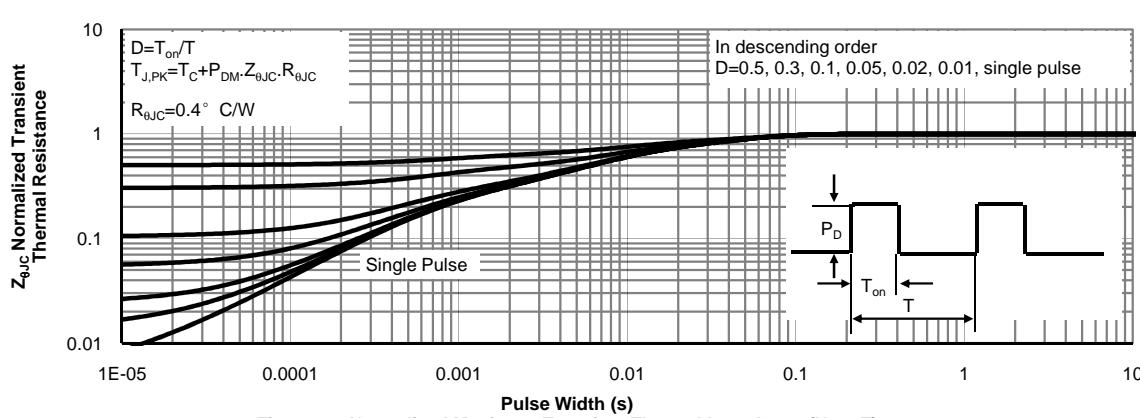
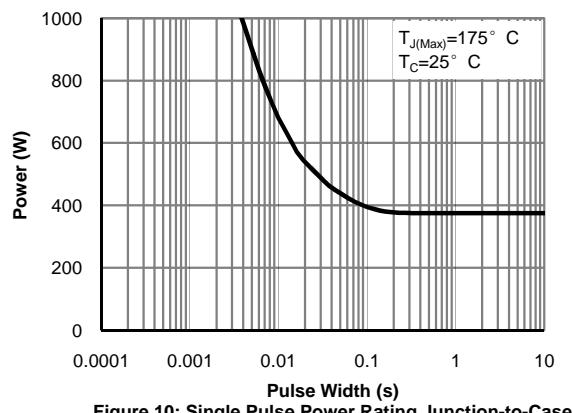
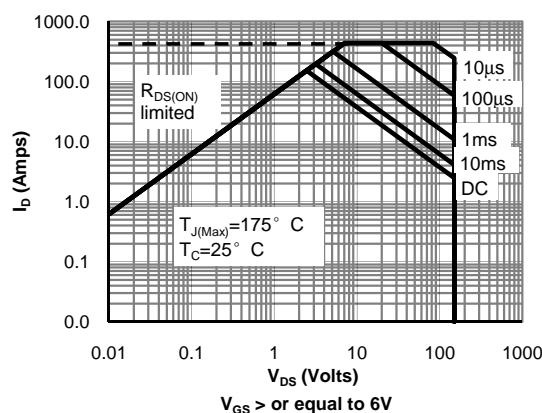
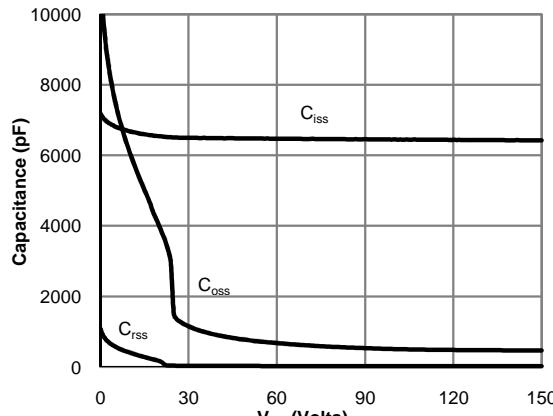
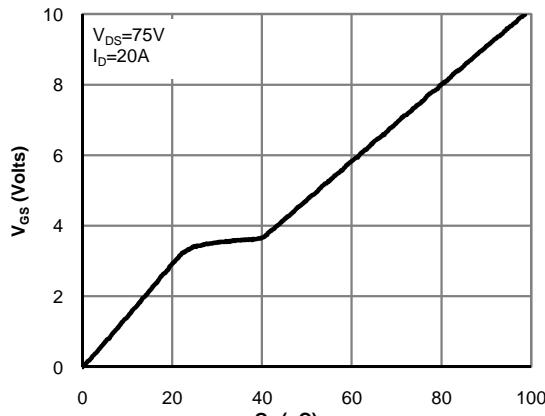


Figure 6: Body-Diode Characteristics (Note E)



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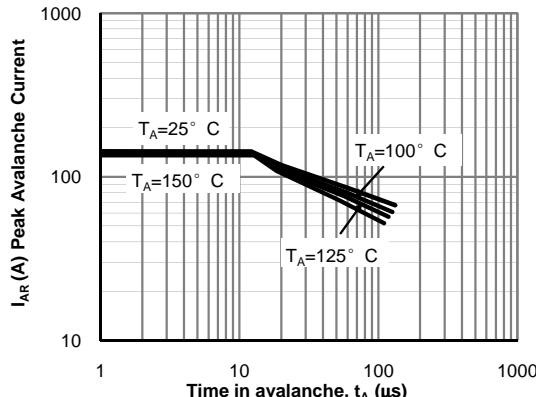


Figure 12: Single Pulse Avalanche capability (Note C)

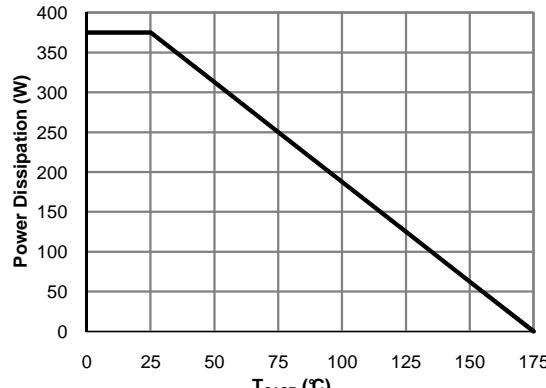


Figure 13: Power De-rating (Note F)

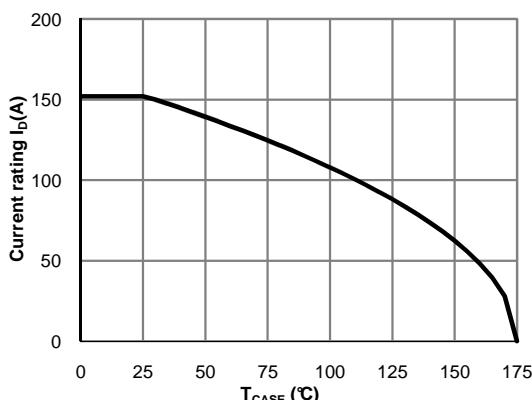


Figure 14: Current De-rating (Note F)

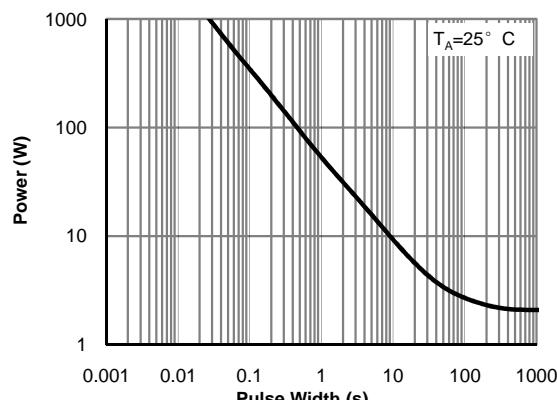


Figure 15: Single Pulse Power Rating Junction-to-Ambient (Note H)

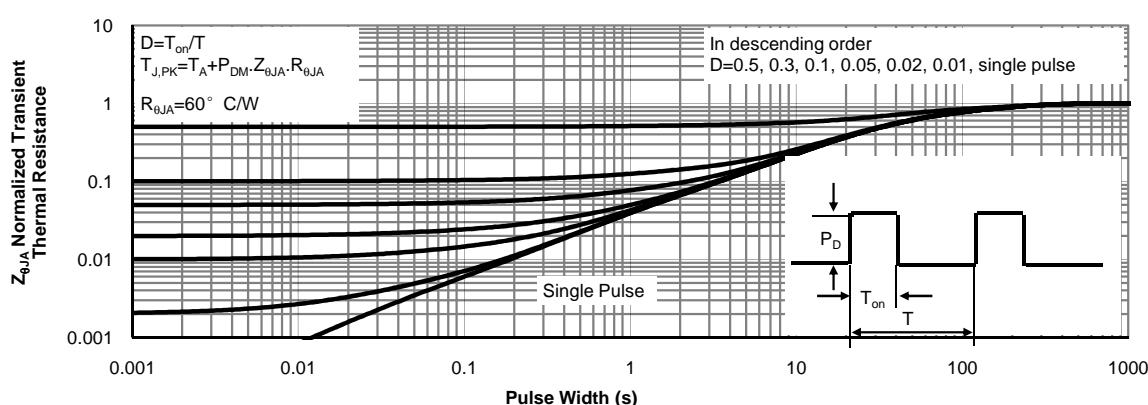
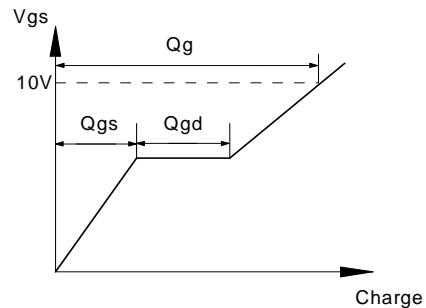
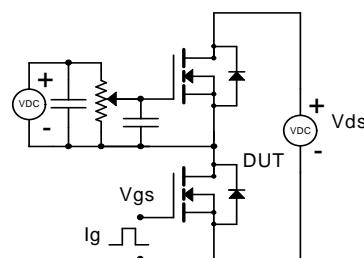


Figure 16: Normalized Maximum Transient Thermal Impedance (Note H)

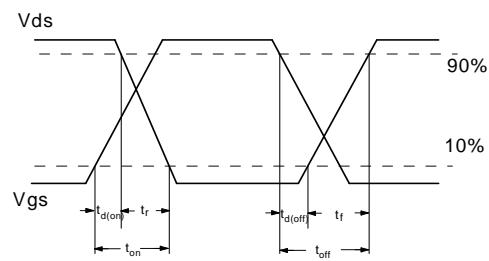
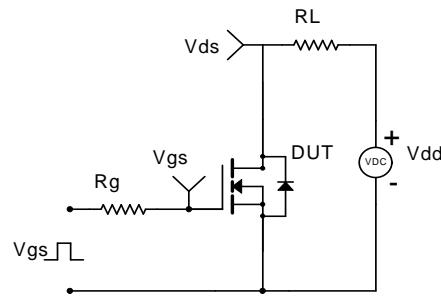


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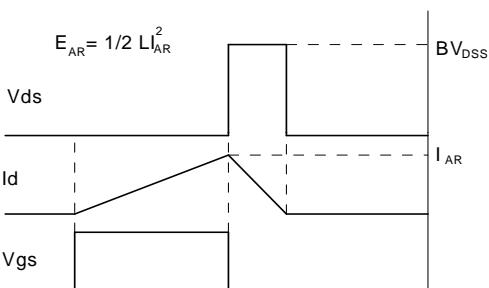
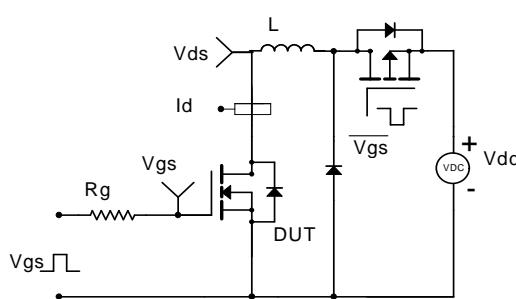
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

